

## **Quarterly Reliability Monitoring Results**

## Quarters: Q1/2021 to Q4/2021

Based on structural similarity

| Supplier                          |   | User Part Number  |                                   |                |           |           |  |
|-----------------------------------|---|---|-----------------------------------|----------------|-----------|-----------|--|
| Nexperia B.V.  Name of Laboratory |   | PZU8.2B2L Part Description  |                                   |                |           |           |  |
|                                   |   |   |                                   |                |           |           |  |
| Assembly reliability labs         |   | MCD package   |                                   |                |           |           |  |
| Based on AEC-Q101 Test            |   | Test Conditions   | # Quantity                        | tity # Rejects |           |           |  |
|                                   | TEST  |   |                                   |                |           |           |  |
|                                   | Pre- and Post-Stress                                    |   |                                   |                |           |           |  |
| # E1                              | Electrical Test   | Tamb = 25 °C  | N/A                               | see below      | all parts | see below |  |
| # A1                              | <b>PC</b> Preconditioning                               | JESD22-A113 Bake Tamb = 125 °C Soak Tamb = 85 °C, RH = 85% Reflow soldering                         | 24 hours<br>168 hours<br>3 cycles | 113            | 9040      | 0         |  |
| # B1                              | HTRB<br>High Temperature Reverse<br>Bias                | MIL-STD-750-1<br>M1038 Method A<br>Tj = Tjmax, Vr = 100% of max. datasheet<br>reverse voltage       | 1000 hours                        | 138            | 11040     | 0         |  |
| # B1b                             | SSOP Steady State Operational                           | MIL-STD-750-1<br>M1038 Method B<br>Tj = Tjmax, Iz = 100% of max. datasheet<br>reverse current       | 1000 hours                        | 20             | 1600      | 0         |  |
| # A4                              | TC<br>Temperature Cycling                               | JESD22-A104<br>-65 °C to Tjmax, not to exceed 150°C   | 1000 cycles                       | 28             | 2240      | 0         |  |
| # A3 alt                          | <b>AC</b><br>Autoclave                                  | JESD22-A102<br>Tamb = 121 °C, RH = 100 %<br>Pressure = 205 kPa (29.7 psia)                          | 96 hours                          | 28             | 2240      | 0         |  |
| # A2 alt                          | H3TRB<br>High Humidity High<br>Temperature Reverse Bias | JESD22-A101 Tamb = 85 °C, RH = 85%, VR = 80 % of rated reverse voltage $^{[1]}$                     | 1000 hours                        | 28             | 2240      | 0         |  |
| # A5                              | IOL Intermittent Operating Life                         | MIL-STD-750 Method 1037 ton = toff, devices powered to insure $\Delta Tj = 100$ °C for 15000 cycles | 1000 hours                        | 29             | 2320      | 0         |  |
| # C8                              | RSH<br>Resistance to Solder Heat                        | JESD22-A111<br>260 °C ± 5 °C  | 10 s                              | n.a.           | n.a.      | n.a.      |  |
| # C10                             | <b>SD</b><br>Solderability                              | J-STD-002   |                                   | 63             | 630       | 0         |  |

<sup>[1]</sup> The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

## **Calculation of FIT and MTTF**

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab | Technology | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|-----------|------------|----------|---------|--------------------|------------|
| Nexperia  |            |          |         |                    |            |
| DHAM      | Zener      | 11040    | 0       | 0.38               | 2.60E+09   |

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